



ZXMP4A16GQ

40V P-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

V(BR)DSS	V(BR)DSS RDS(on) MAX	
-40V	60mΩ @ V _{GS} = -10V	-6.4A
-40 V	100mΩ @ V _{GS} = -4.5V	-5.6A

Description and Applications

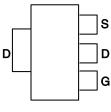
This new generation of Trench MOSFETs utilizes a unique structure that combines the benefits of low on-resistance with fast switching speed. This makes them ideal for high efficiency, low voltage, and power management applications.

- DC-DC Converters
- Disconnect Switches
- Audio Output Stages
- Motor Control

SOT223



Top View



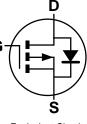
Pin Out - Top View

Features and Benefits

- Low On-Resistance
- Fast Switching Speed
- Low Threshold
- Low Gate Drive
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

Mechanical Data

- Case: SOT223
- Case Material: Molded Plastic, UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208
- Weight: 0.112 grams (Approximate)



Equivalent Circuit

Ordering Information (Note 5)

Product	Case	Packaging
ZXMP4A16GQTA	SOT223	1,000/Tape & Reel
ZXMP4A16GQTC	SOT223	4,000/Tape & Reel

Notes: 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.

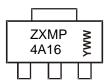
2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. Automotive products are AEC-Q101 qualified and are PPAP capable. Automotive, AEC-Q101 and standard products are electrically and thermally the same, except where specified. For more information, please refer to http://www.diodes.com/quality/product_grade_definitions/.

5. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



ZXMP4A16 = Product Type Marking Code YWW = Date Code Marking Y = Year (ex: 4 = 2014) WW = Week (01 - 53)



Maximum Ratings (@T_A = +25°C unless otherwise specified.)

Characteristic Drain-Source Voltage		Symbol	Value	Unit	
			V _{DSS}	-40	V
Gate-Source Voltage			V _{GS}	±20	V
		(Note 7)		-6.4	
Continuous Drain Current	$V_{GS} = 10V$	$T_A = +70^{\circ}C$ (Note 7)	ID	-4.6	А
		(Note 6)		-1.7	
Pulsed Drain Current	V _{GS} = 10V	(Note 8)	I _{DM}	-21	А
Continuous Source Current ((Body diode)	(Note 7)	Is	-5.2	A
Pulsed Source Current (Bod	y diode)	(Note 8)	I _{SM}	-21	A

Thermal Characteristics @T_A = 25°C unless otherwise specified

Characteristic		Symbol	Value	Unit	
Power Dissipation	(Note 6)		2.0 16	W	
Linear Derating Factor	(Note 7)		3.9 31	mW/°C	
Thermal Resistance, Junction to Ambient	(Note 6)	5	62.5	°C/W	
	(Note 7)	R ₀ JA	32.2	°C/VV	
Operating and Storage Temperature Range		T _J , T _{STG}	-55 to 150	C°	

Electrical Characteristics @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test C	Condition
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage	BV _{DSS}	-40			V	$I_D = -250 \mu A, V_{GS} = 0 V$	
Zero Gate Voltage Drain Current	I _{DSS}		_	-1	μA	V _{DS} = -40V, V _{GS} = 0V	
Gate-Source Leakage	I _{GSS}	_	_	100	nA	V_{GS} = ±20V, V_{DS}	= 0V
ON CHARACTERISTICS							
Gate Threshold Voltage	V _{GS(th)}	-1.0			V	I_D = -250µA, V_{DS}	= V _{GS}
Static Drain-Source On-Resistance (Note 9)	Р			0.060	Ω	V_{GS} = -10V, I_{D} = -	-3.8A
Static Drain-Source On-Resistance (Note 9)	R _{DS (ON)}	_	_	0.100		V_{GS} = -4.5V, I_{D} =	-2.9A
Forward Transconductance (Notes 9 & 11)	g fs	_	8.85	_	S	V _{DS} = -15V, I _D = -	3.8A
Diode Forward Voltage (Note 9)	V _{SD}	_	-0.85	-1.2	V	$T_J = 25^{\circ}C$, $I_S = -$	3.4A, V _{GS} = 0V
Reverse Recovery Time (Note 11)	trr		27.2	_	ns	T _J = +25°C , I _F = -3A, di/dt= 100A/μs	
Reverse Recovery Charge (Note 11)	Qrr	_	25.4	—	nC		
DYNAMIC CHARACTERISTICS (Note 11)							
Input Capacitance	C _{iss}	_	1007	_	pF	V _{DS} = -20V, V _{GS} = 0V f= 1MHz	
Output Capacitance	C _{oss}	_	130	_	pF		
Reverse Transfer Capacitance	C _{rss}	_	85		pF		
Total Gate Charge (Note 10)	Qg		13.6		nC	V _{GS} = -5V	
Total Gate Charge (Note 10)	Qg		26.1		nC	V _{GS} = -10V V _{DS} = -20V I _D = -3.8A	
Gate-Source Charge (Note 10)	Q _{gs}		2.8		nC		
Gate-Drain Charge (Note 10)	Q _{gd}		4.8	—	nC		
Turn-On Delay Time (Note 10)	t _{D(on)}		3.0	—	ns	$V_{DD}\text{=-}20\text{V}, \text{V}_{GS}\text{=-}10\text{V}, \\ \text{I}_{D}\text{=-}1\text{A}, \text{R}_{G}\cong 6.0\Omega$	
Turn-On Rise Time (Note 10)	tr	_	3.5		ns		
Turn-Off Delay Time (Note 10)	t _{D(off)}	_	13.4	_	ns		
Turn-Off Fall Time (Note 10)	t _f	_	7.2	_	ns		

6. For a device surface mounted on 25mm x 25mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions. Notes:

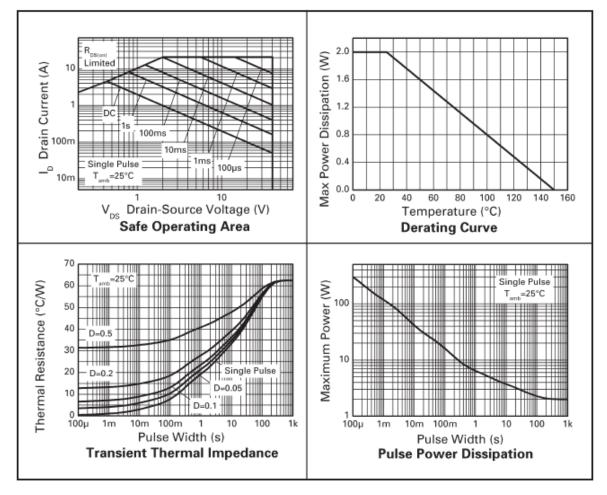
To a device surface mounted on FR4 PCB measured at t ≤ 10 seconds.
 For a device surface mounted on 25mm x 25mm FR4 PCB, D= 0.05 pulse width limited by maximum junction temperature.
 Measured under pulsed conditions. Width ≤ 300µs. Duty cycle ≤ 2%.

10. Switching characteristics are independent of operating junction temperature.

11. For design aid only, not subject to production testing.

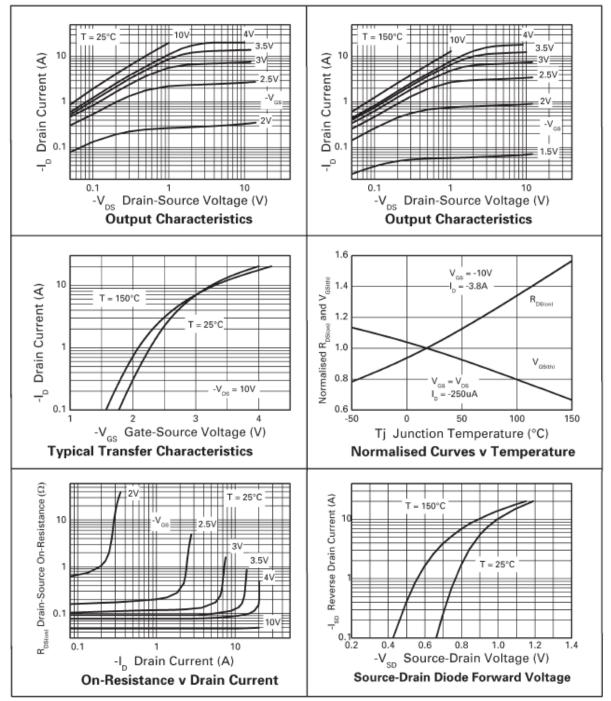


CHARACTERISTICS

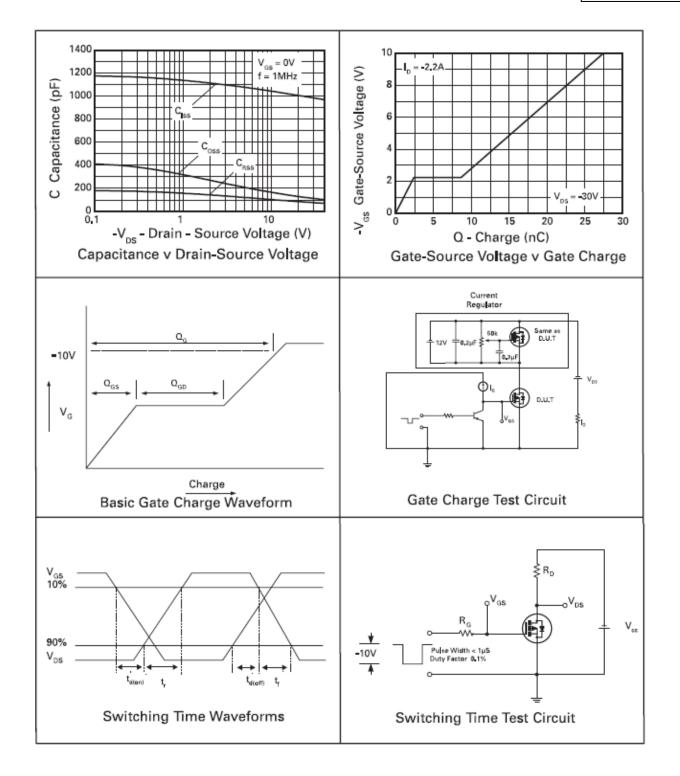




TYPICAL CHARACTERISTICS



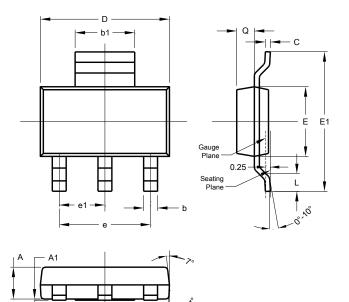






Package Outline Dimensions

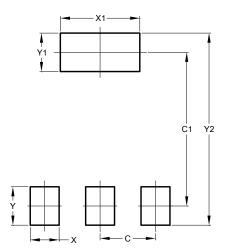
Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



	SOT223				
Dim	Min	Max	Тур		
Α	1.55	1.65	1.60		
A1	0.010	0.15	0.05		
b	0.60	0.80	0.70		
b1	2.90	3.10	3.00		
С	0.20	0.30	0.25		
D	6.45	6.55	6.50		
Е	3.45	3.55	3.50		
E1	6.90	7.10	7.00		
е	-	-	4.60		
e1	-	-	2.30		
L	0.85	1.05	0.95		
Q	0.84	0.94	0.89		
All [All Dimensions in mm				

Suggested Pad Layout

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



Dimensions	Value (in mm)		
С	2.30		
C1	6.40		
Х	1.20		
X1	3.30		
Y	1.60		
Y1	1.60		
Y2	8.00		



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